



- ✧ Low profile package
- ✧ Built-in stain relief, ideal for automatic placement
- ✧ Fast switching for high efficiency
- ✧ High temperature soldering:
260°C/10 seconds at terminals
- ✧ Meet MSL level 1, per J-STD-020D,
lead free maximum peak of 260°C
- ✧ Plastic material used carries Underwriters
Laboratory Classification 94V-0
- ✧ Green compound with suffix "G" on packing
code & prefix "G" on datecode

Mechanical Data

- ✧ Cases: Molded plastic
- ✧ Terminal: Pure tin plated, lead free
- ✧ Polarity: Indicated by cathode band
- ✧ Packing: 16mm tape per EIA STD RS-481
- ✧ Weight: 0.21 grams

Ordering Information (example)

Part No.	Package	Packing	Packing code	Packing code (Green)
HS3A	SMC	850 / 7" REEL	R7	R7G

Maximum Ratings and Electrical Characteristics

Rating at 25 °C ambient temperature unless otherwise specified.

Parameter	Symbol	HS 3A	HS 3B	HS 3D	HS 3F	HS 3G	HS 3J
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	300	400	600
Maximum RMS Voltage	V_{RMS}	35	70	140	210	280	420
Maximum DC Blocking Voltage	V_{DC}	50	100	200	300	400	600
Maximum Average Forward Rectified Current	$I_{F(AV)}$	3					
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}	150					
Maximum Instantaneous Forward Voltage (Note 1) @ 3A	V_F	1.0				1.3	
Maximum DC Reverse Current at @ $T_A=25\text{ }^\circ\text{C}$ Rated DC Blocking Voltage @ $T_A=125\text{ }^\circ\text{C}$	I_R	10 250					
Maximum Reverse Recovery Time (Note 2)	T_{rr}	50					
Typical Junction Capacitance (Note 3)	C_j	80					
Typical Thermal Resistance	$R_{\theta JA}$	60					
Operating Temperature Range	T_J	- 55 to + 150					
Storage Temperature Range	T_{STG}	- 55 to + 150					

Note 1: Pulse Test with PW=300 usec, 1% Duty Cycle

Note 2: Reverse Recovery Test Conditions: $I_F=0.5A$, $I_R=1.0A$, $I_{RR}=0.25A$

Note 3: Measured at 1 MHz and Applied $V_R=4.0$ Volts

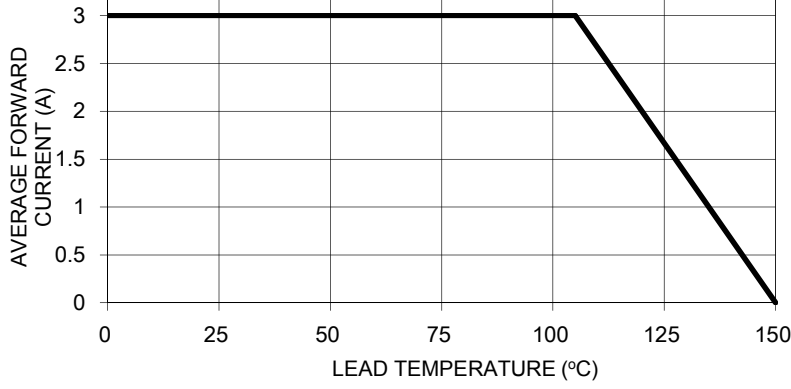


FIG. 3- MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

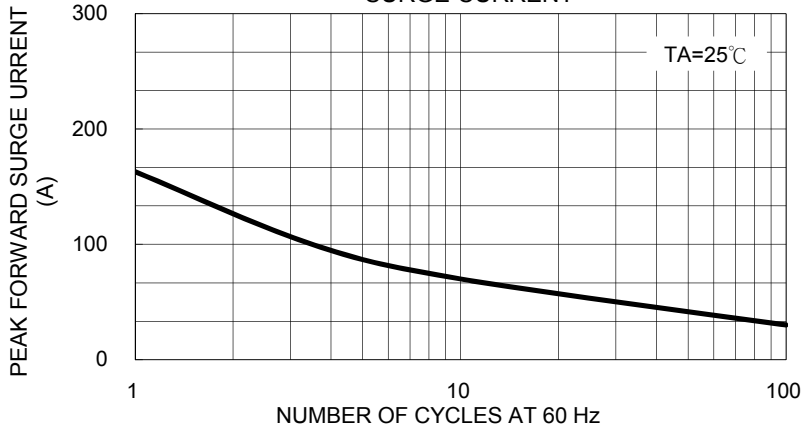


FIG. 4- TYPICAL JUNCTION CAPACITANCE

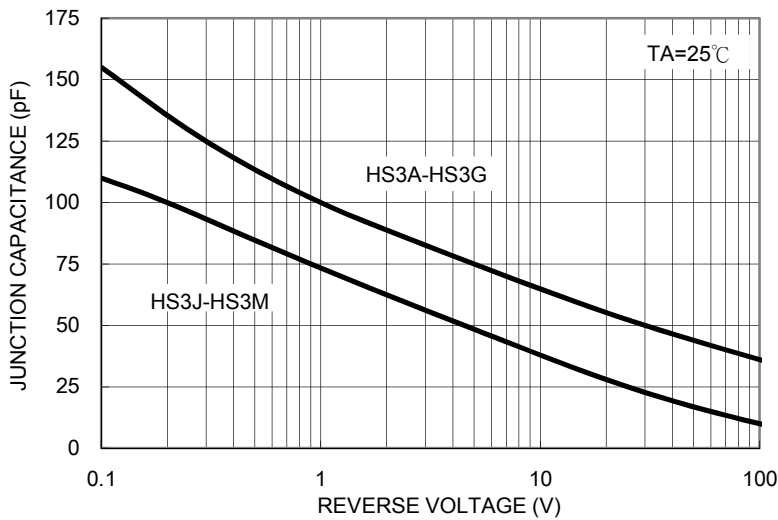


FIG. 6- REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM

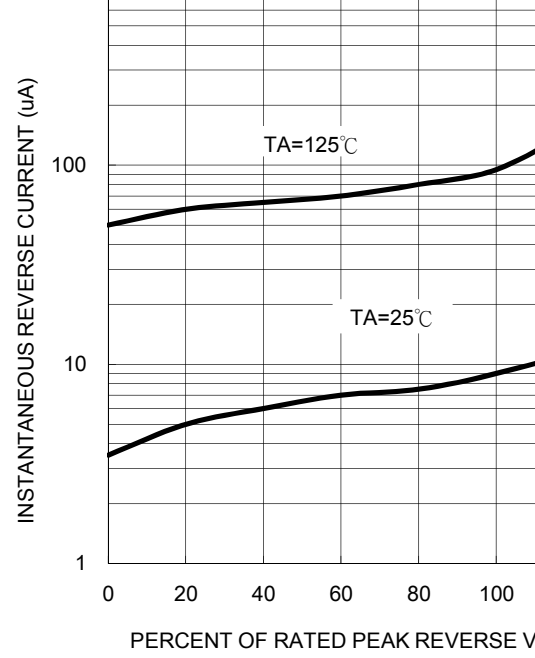
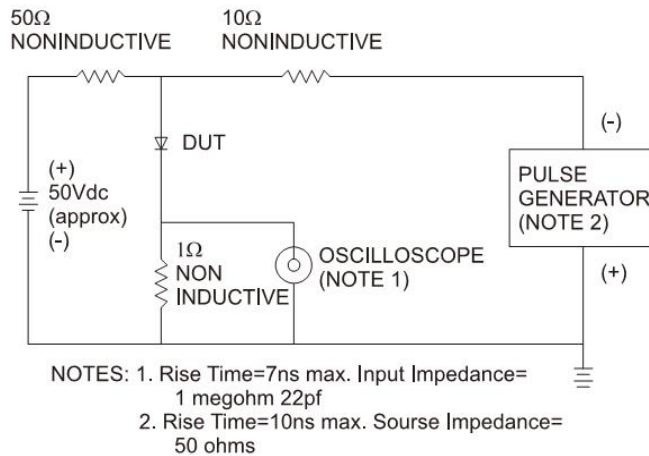
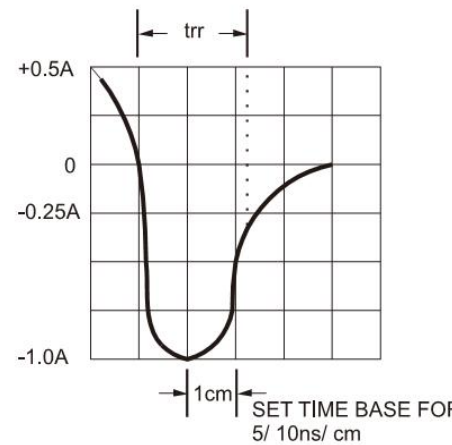
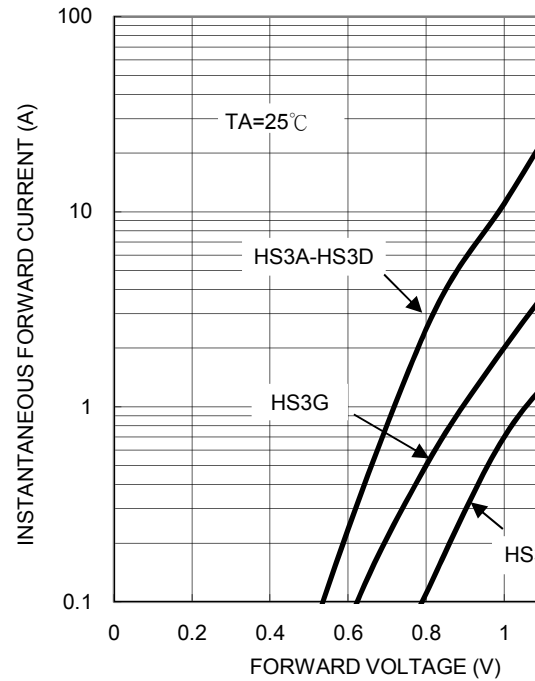


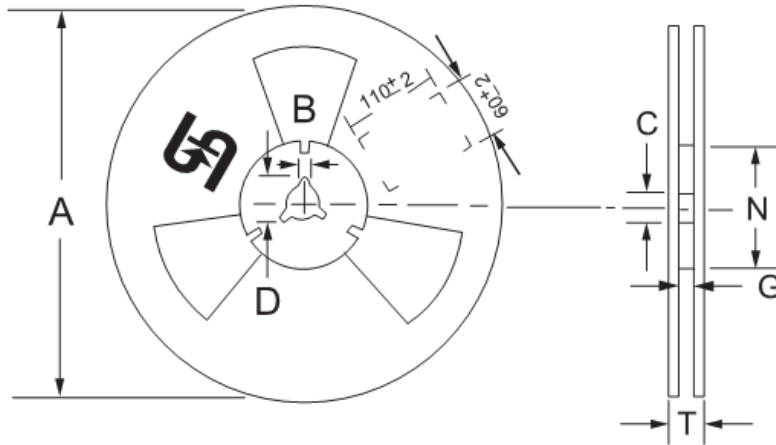
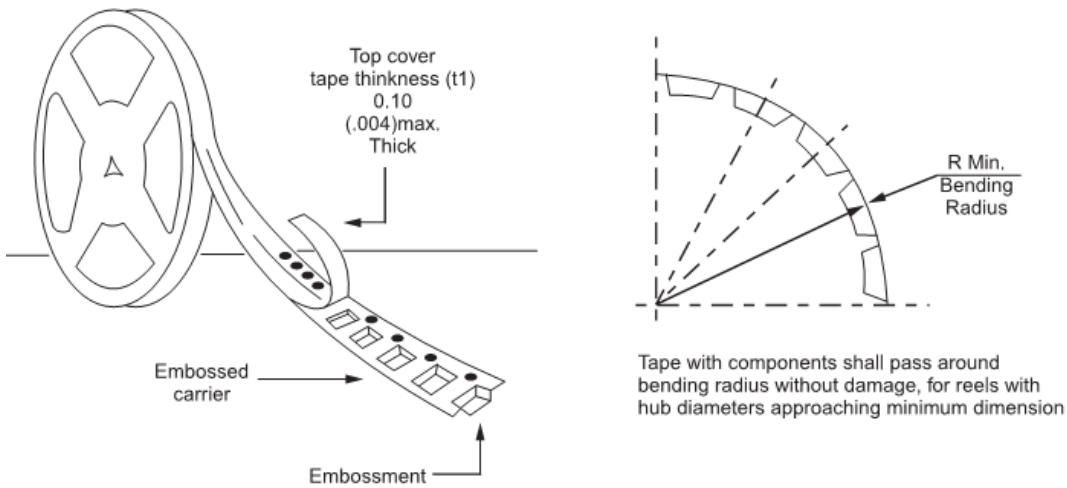
FIG. 5- TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS



HS3x (Note)	SMC	3K / 13" REEL	R6	R6G
	SMC	3K / 13" Plastic REEL	M6	M6G

Note: "x" is Device Code from "A" thru "M".

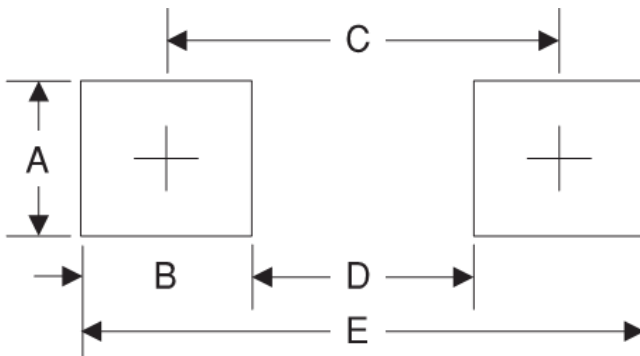
Tape & Reel specification



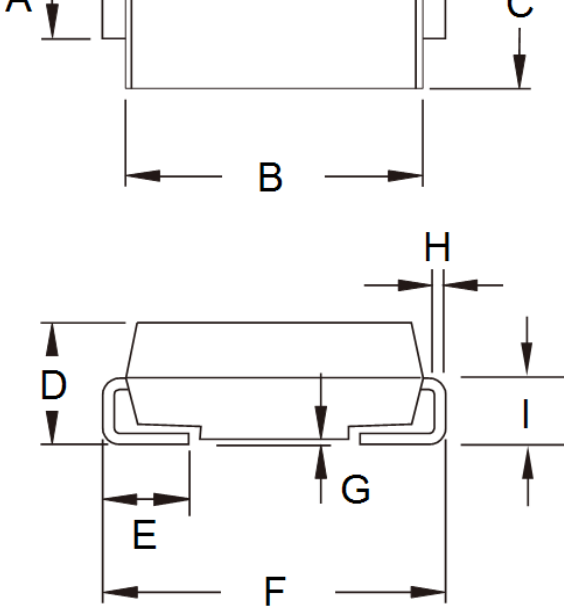
Reel Size	Tape Size	A	B	C	D	N	G	T
		±2.0	±0.4	+0.5;-0.2	min	±1.0	+0.8;-0	max
7"	16mm	178	1.9	13	21	62	16.2	18.6
Reel Size	Tape Size	A	B	C	D	N	G	T
		max	±0.5	±0.5	min	±0.5	+2.0;-0	max
13"	16mm	330	2	13	20.2	75	16.4	22.4

Unit (mm)

Suggested PAD Layout



Symbol	Unit(mm)
A	3.3
B	2.5
C	6.8
D	4.4
E	9.3



DIM.	Unit(mm)		Unit(inch)	
	Min	Max	Min	Max
A	2.90	3.20	0.114	0.126
B	6.60	7.11	0.260	0.280
C	5.59	6.22	0.220	0.245
D	2.00	2.62	0.079	0.103
E	1.00	1.60	0.039	0.063
F	7.75	8.13	0.305	0.320
G	0.10	0.20	0.004	0.008
H	0.15	0.31	0.006	0.012
I	1.26	1.56	0.050	0.061

Marking Diagram



- P/N = Specific Device Code
- G = Green Compound
- YW = Date Code
- F = Factory Code